FAIRCHILD SEMICONDUCTOR®

February 2012

FFP30S60S

STEALTH™ II Rectifier

Features

- High Speed Switching, t_{rr} < 40ns @ I_F = 30A
- High Reverse Voltage and High Reliability
- RoHS compliant

Applications

- General Purpose
- Switching Mode Power Supply
- Boost Diode in continuous mode power factor corrections
- Power switching circuits

30A, 600V STEALTH™ II Rectifier

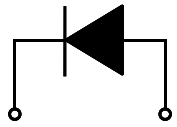
The FFP30S60S is STEALTH™ II rectifier with soft recovery charac-teristics. It is silicon nitride passivated ion-implanted epi-taxial planar construction.

This device is intended for use as freewheeling of boost diode in switching power supplies and other power swithching applica-tions. Their low stored charge and hyperfast soft recovery mini-mize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Pin Assigments

TO-220-2L

1. Cathode 2. Anode



1. Cathode 2. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V_{RWM}	Working Peak Reverse Voltage	600	V
V_R	DC Blocking Voltage	600	V
$I_{F(AV)}$	Average Rectified Forward Current @ T_C = 103°C	30	A
I_{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	300	A
T_J, T_{STG}	Operating and Storage Temperature Range	-65 to +150	°C

Thermal Characteristics

Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	1.1	°C/W

Package Marking and Ordering Information

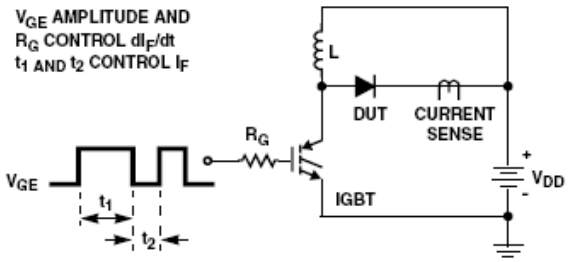
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F30S60S	FFP30S60STU	TO-220-2L	-	-	50

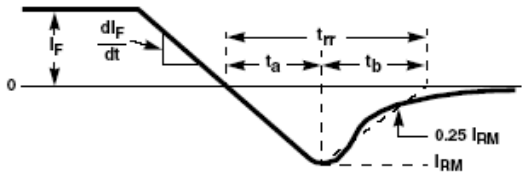
Electrical Characteristics $T_C = 25^oC$ unless otherwise noted

Symbol	Parameter		Min.	Typ.	Max.	Units
$V_{FM}1$	I_F = 30A I_F = 30A	$T_C = 25^oC$ $T_C = 125^oC$	- -	2.1 1.6	2.6 -	V
$I_{RM}1$	V_R = 600V V_R = 600V	$T_C = 25^oC$ $T_C = 125^oC$	- -	- -	100 500	μA
t_{rr}	I_F = 1A, di/dt = 100A/μs, V_R = 30V	$T_C = 25^oC$	-	25	35	ns
t_{rr} I_{rr} S factor Q_{rr}	I_F = 30A, di/dt = 200A/μs, V_R = 390V	$T_C = 25^oC$	- - - -	28 2.4 0.9 34	40 - - -	ns A nC
t_{rr} I_{rr} S factor Q_{rr}	I_F = 30A, di/dt = 200A/μs, V_R = 390V	$T_C = 125^oC$	- - - -	75 6.3 0.9 236	- - - -	ns A nC
W_{AVL}	Avalanche Energy (L = 40mH)		20	-	-	mJ

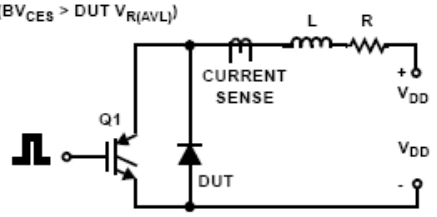
Notes:
1: Pulse: Test Pulse width = 300μs, Duty Cycle = 2%

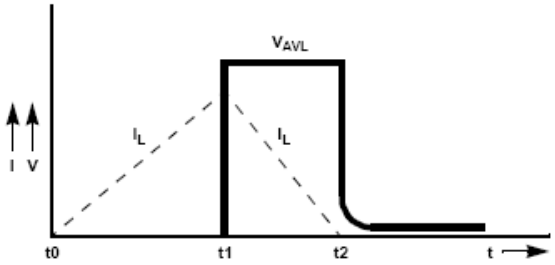
Test Circuit and Waveforms





L = 40mH
R < 0.1Ω
V_{DD} = 50V
EAVL = 1/2LI2 [$V_{R(AVL)}$/($V_{R(AVL)}$ - V_{DD})]
Q1 = IGBT (BV_{CES} > DUT $V_{R(AVL)}$)





Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop vs. Forward Current

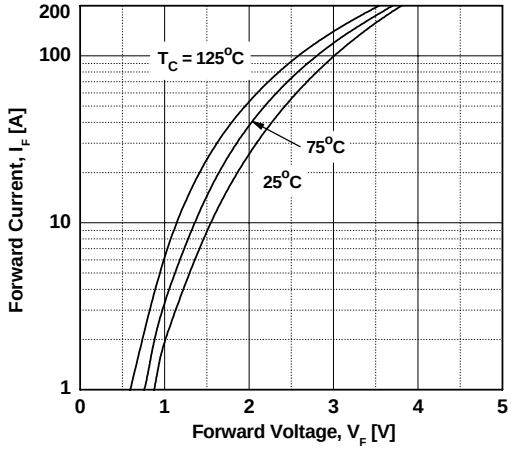


Figure 2. Typical Reverse Current vs. Reverse Voltage

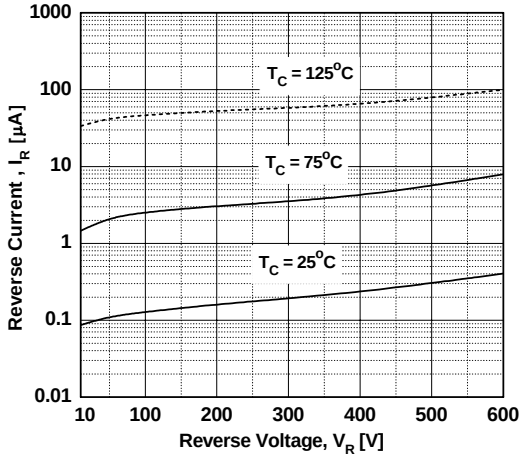


Figure 3. Typical Junction Capacitance

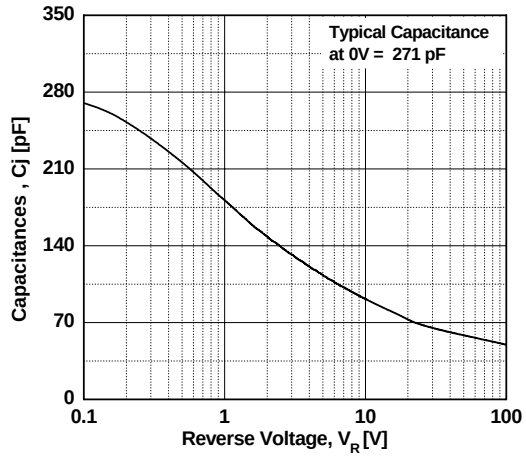


Figure 4. Typical Reverse Recovery Time vs. di/dt

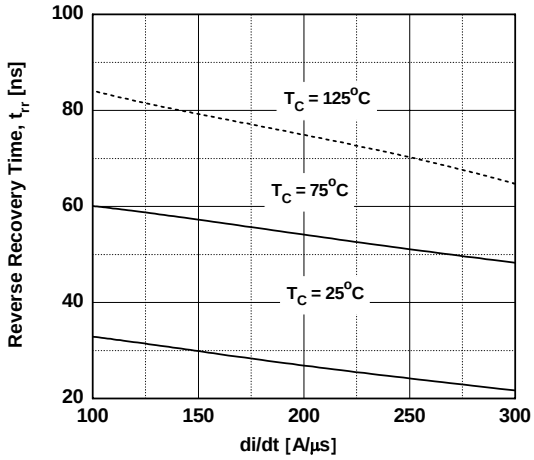


Figure 5. Typical Reverse Recovery Current vs. di/dt

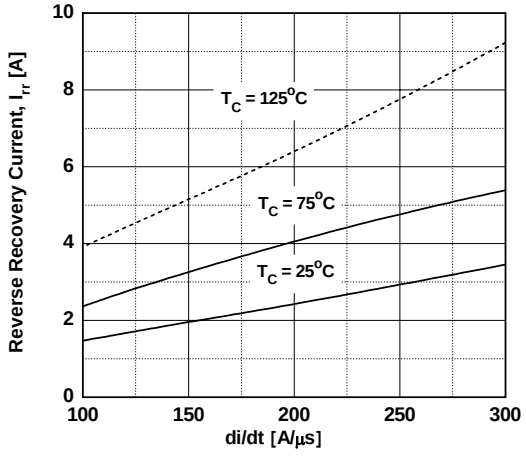
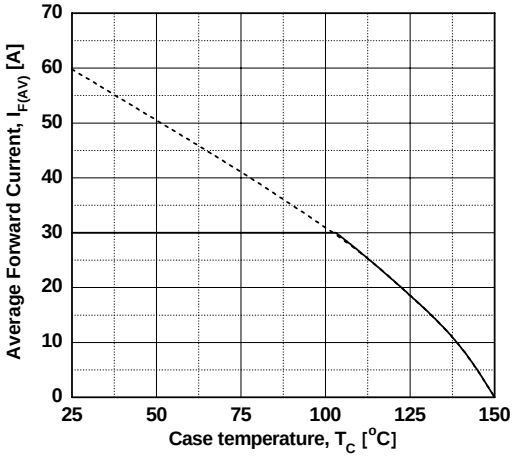
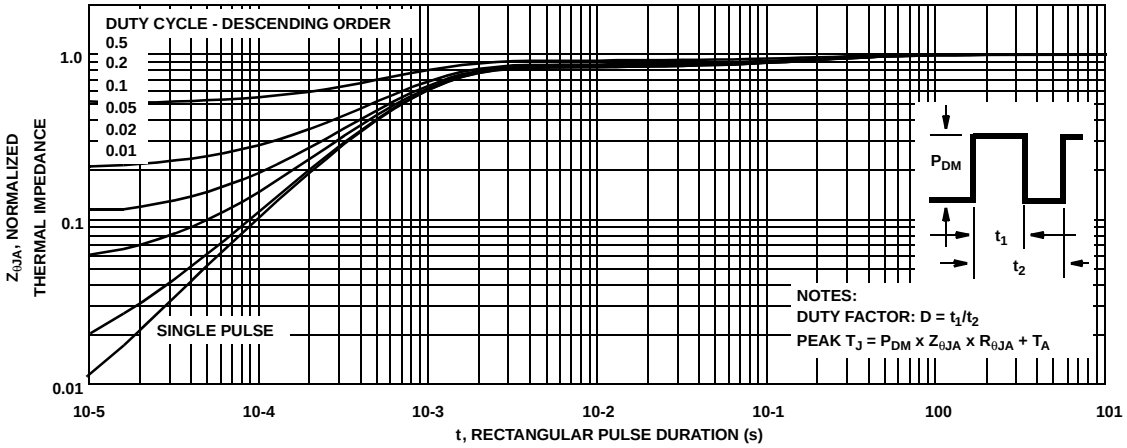


Figure 6. Forward Current Derating Curve



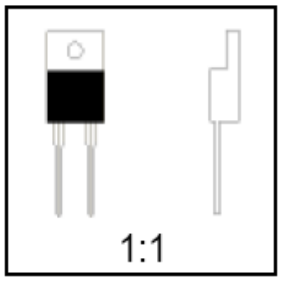
Typical Performance Characteristics

Figure 7. Normalized Maximum Transient Thermal Impedance



Mechanical Dimensions

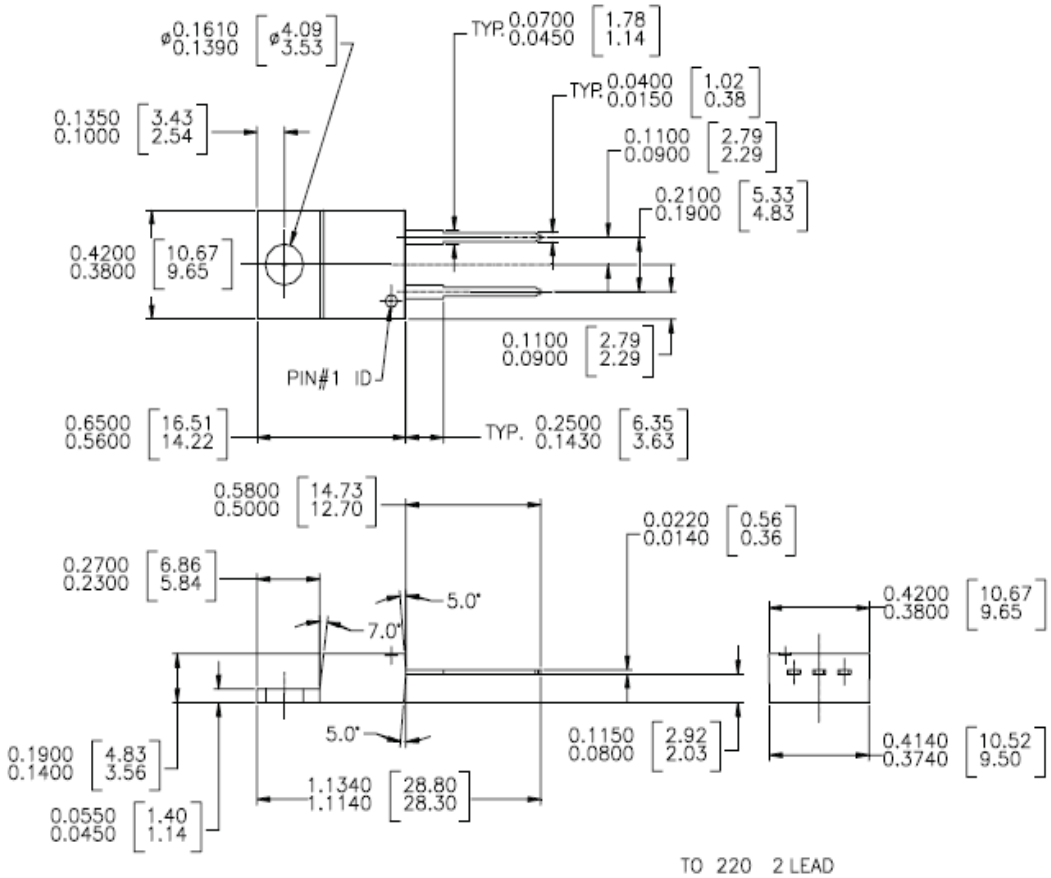
TO-220-2L



Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 2.24



TO 220 2 LEAD

NOTE : UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH :
200 MICROINCHES / 5.08 MICRON MINIMUM
LEAD / TIN 15/85 ON OLIN 194 COPPER OR EQUIVALENT

2. DIMENSION BASED ON JEDEC STANDARD TO-220
VARIATION AB, ISSUE J, DATED 3/24/87

Dimensions in Millimeters

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Rev. I61